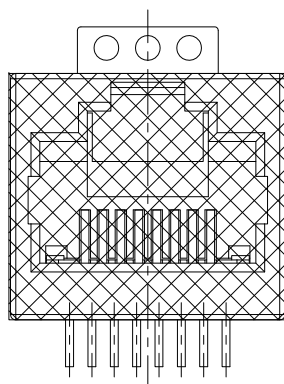
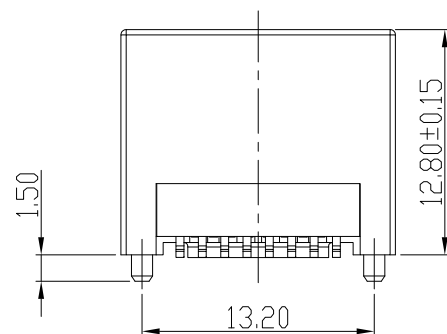
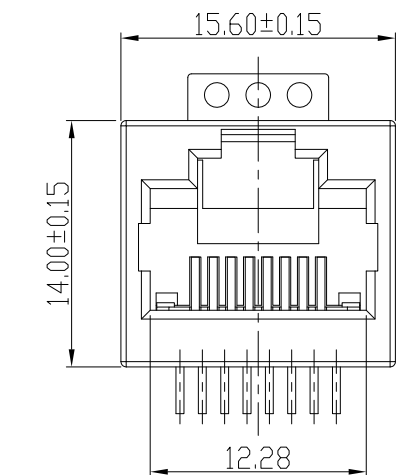
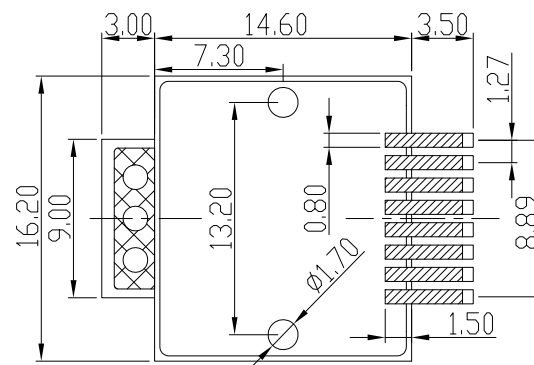
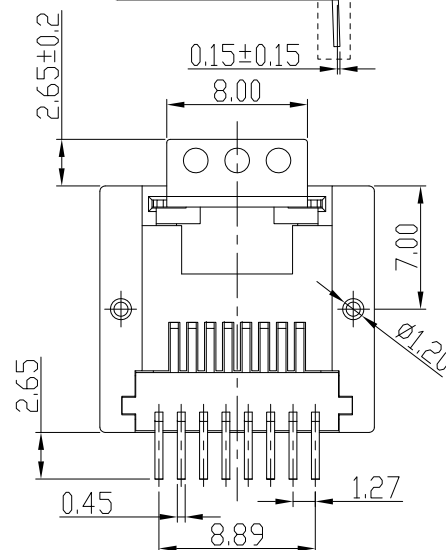
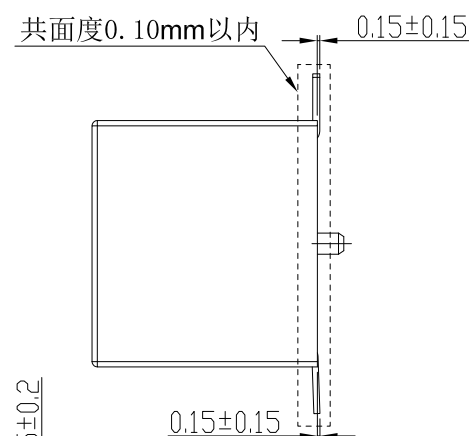


GP Component

REV.	ECN NO.	LOCATIONS	DESCRIPTION	DATE	DESIGN
A0			Initial	2016/09/08	Phebe Su



贴麦拉图示



PCB LAYOUT/TOP VIEW

TOLERANCE=±0.05

NOTES

MATERIAL

1. HOUSING MATERIAL : LCP BLACK, UL94V-0
2. CONTACT MATERIAL : C5191-H T=0.35mm.
3. PLATING : G/F PLATING OVER NICKEL.

ELECTRICAL

1. VOLTAGE RATING : 125 VAC RMS.
2. CURRENT RATING : 1.5 AMP.
3. CONTACT RESISTANCE : 20 MILLIOHMS MAX.
4. INSULATION RESISTANCE : 1000 MEGOHMS MIN @ 500V DC .
5. DIELECTRIC DIELECTRIC RESISTANCE: 1000V AC RMS 50Hz. 1MIN.

MECHANICAL

1. DURABILITY : 750 CYCLES MIN.
2. PCB RETENTIONPRE-SOLDER : 1 LB MIN.

ENVIRONMENTAL:

1. STORAGE : -40℃~+85℃.
2. OPERATION : -40℃~+85℃.

MATRIX PART NO:

MRJ N - 11 S549 I RS

Matrix-RJ45

F: 10/100

G: 10/100/1000

N: Pure Connector

11:1X1 ; 21:2X1
12:1X2 ; 22:2X2
14:1X4 ; 24:2X4
16:1X6 ; 26:2X6
18:1X8 ; 28:2X8
1U:RJ+USB

RS: ROHS
HF: Halogen Free
Industrial temperature
Series Number

S: SMD
T: THT

NO	VARIETY	QTY	METERIAL	REMARK
 Matrix Electronics Co.,Ltd				
TOLERANCE: X.X ±0.20 X.XX ±0.15 X.XXX ±0.075 ANGLE: ±3°		DESIGN BY : Phebe Su	DATE : 2016/09/08	PART NAME: RJ45 1x1 JACK W/O LED & SHELL SMD
CHECKED BY: Vicky Hsieh		DATE : 2016/09/08	PART NO.	MRJN-11S549TRS
APPROVED BY1: Richard Hsieh		DATE : 2016/09/08	MOLD NO.	NA
UNIT: mm [inch]		APPROVED BY2: Richard Hsieh	DATE : 2016/09/08	DRAW NO.
SCALE:1:1	SIZE:A4		SHEET NO.	1 OF 1